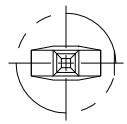
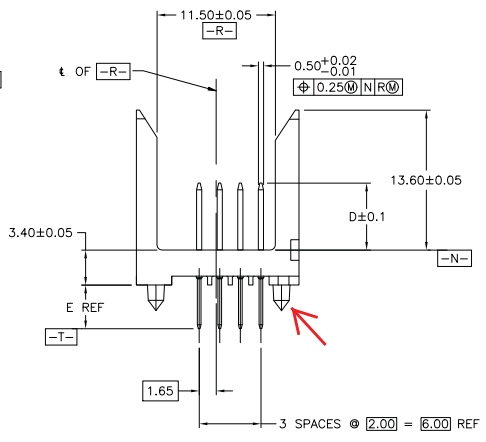
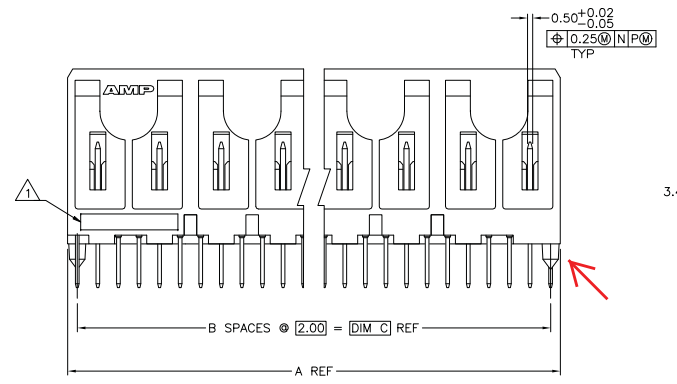
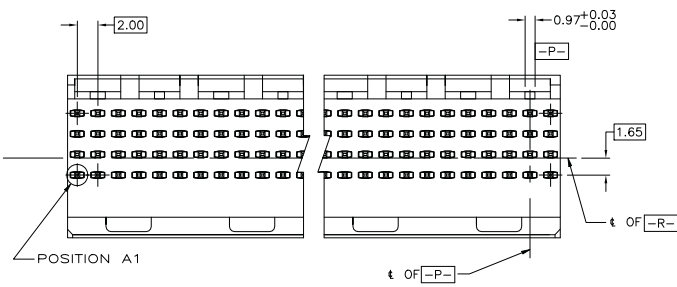
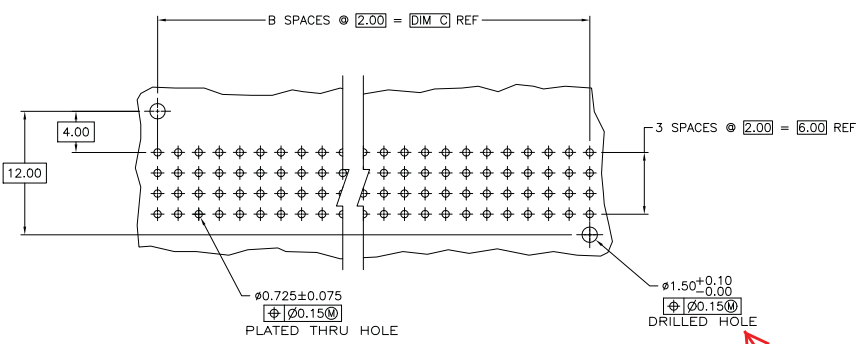
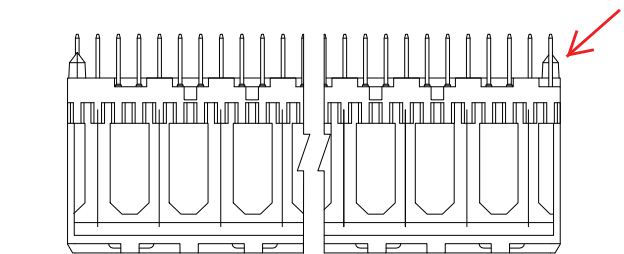
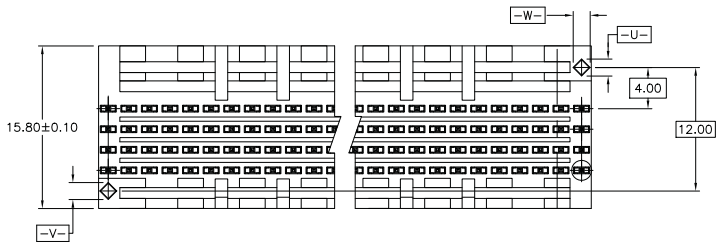


REVISIONS				
#	UR	DESCRIPTION	DATE	OWN / APP'D
A3		REVISED PER ECO-20-013368	24SEP2020	RZ / HL



DETAIL Z
SCALE 20:1



RECOMMENDED CIRCUIT PATTERN
PER IPC-D300 TYPE II, CLASS C
(COMPONENT SIDE)

- ⚠ HOUSING MATERIAL: LIQUID CRYSTAL POLYMER PER ASTM D5138 LCPO00 G30A 32250.
- ⚠ CONTACT MATERIAL: PHOSPHOR BRONZE.
- ⚠ CONTACT FINISH:
UNDERPLATE (ENTIRE CONTACT):
0.00127 MIN NICKEL PER SAE-AMS-QQ-N-290.
ON MATING SURFACES:
CONFORMS TO ALL TESTING SPECIFIED FOR TELCORDIA UNCONTROLLED ENVIRONMENT.
ON LEADS
0.00381 MIN TIN PER ASTM B 545 OVER UNDERPLATE.
LUBRICATION (MIN MATING SURFACES):
SURFACE CONDITIONER AFTER PLATING.
- ⚠ PART MARKING, LOCATED APPROXIMATELY AS SHOWN.
- ⚠ OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI

4.25	6.5	46	23	47.88	96	5536501-3
E	D	C	B	A	FINISH	NO OF POSN
						PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT. **TE** TE Connectivity

DESIGNER: B. MCMASTER	DATE: 30AUG04
APPROVED: R. WERTZ	DATE: 30AUG04
PRODUCT SPEC: Z-PACK 2mm FB, SIGNAL MODULE, PIN ASSEMBLY	2mm
APPLICATION SPEC: ---	RESTRICTED TO: ---
WEIGHT: 0.000000	SIZE: A1
CUSTOMER DRAWING	SCALE: 4:1